

## Features

- ESD Protection for 1 Line with Bi-directional
- Provide ESD protection for the protected line to IEC 61000-4-2 (ESD)  $\pm 17\text{kV}$  (air),  $\pm 15\text{kV}$  (contact) IEC 61000-4-5 (Lightning) 4A (8/20 $\mu\text{s}$ )
- Ultra low capacitance: 0.45pF typical
- Ultra low leakage current
- For low operating voltage applications: 3.3V and below
- 0402 small DFN package saves board space
- Protect one I/O line
- Fast turn-on and low clamping voltage
- Solid-state silicon-avalanche and active circuit triggering technology
- **Green Part**

## Applications

- Hand Held Portable Applications
- Wearable Devices
- Antenna applications
- USB3.0 / USB2.0
- High Definition Multi-media Interface (HDMI)
- Digital Visual Interface (DVI)
- Display Port
- Serial ATA

## Description

AZ5323-01F is a design which includes a bi-directional ESD rated clamping cell to protect high speed data interfaces in an electronic system. The AZ5323-01F has been specifically designed to protect sensitive components which

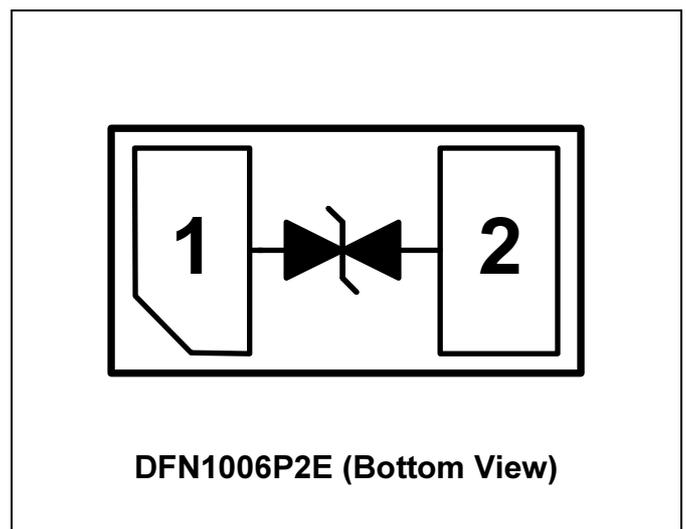
are connected to data and transmission lines from over-voltage caused by Electrostatic Discharging (ESD).

AZ5323-01F is a unique design which includes proprietary clamping cells with ultra low capacitance in a small package. During transient conditions, the proprietary clamping cells prevent over-voltage on the control/data lines, protecting any downstream components.

AZ5323-01F is bi-directional and may be used on lines where the signal swings above and below ground.

AZ5323-01F may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 ( $\pm 15\text{kV}$  air,  $\pm 8\text{kV}$  contact discharge).

## Circuit Diagram / Pin Configuration





## SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS			
PARAMETER	SYMBOL	RATING	UNITS
Peak Pulse Current (tp =8/20μs)	I <sub>PP</sub>	4	A
Operating DC Voltage	V <sub>DC</sub>	±3.6	V
ESD per IEC 61000-4-2 (Air)	V <sub>ESD</sub>	±17	kV
ESD per IEC 61000-4-2 (Contact)		±15	kV
Lead Soldering Temperature	T <sub>SOL</sub>	260 (10 sec.)	°C
Operating Temperature	T <sub>OP</sub>	-55 to +85	°C
Storage Temperature	T <sub>STO</sub>	-55 to +150	°C

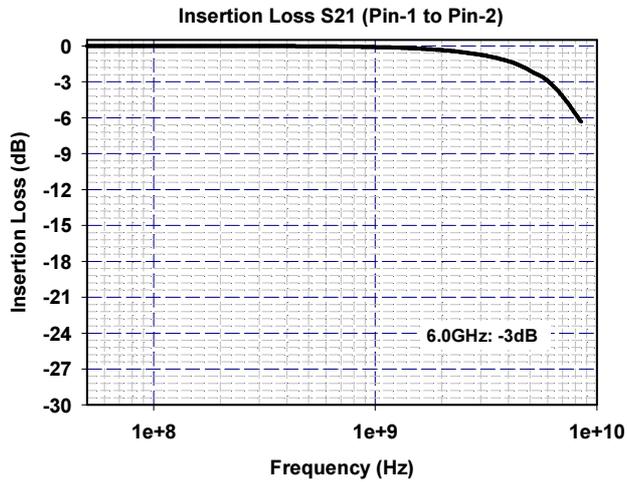
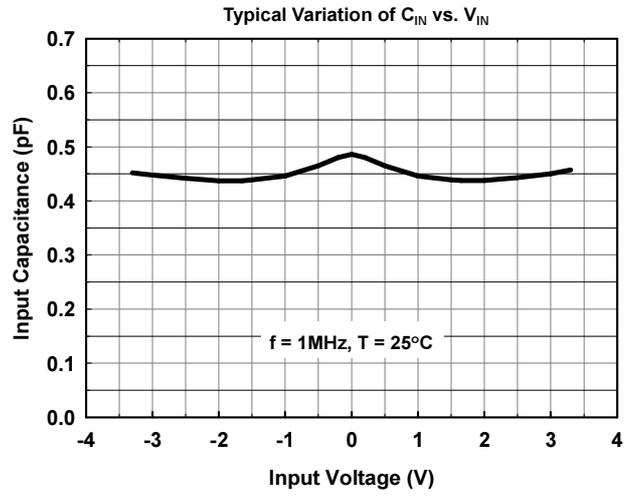
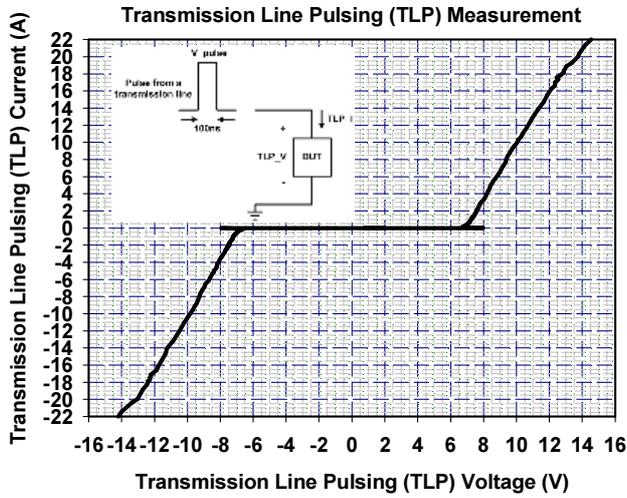
ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	CONDITIONS	MINI	TYP	MAX	UNITS
Stand-Off Voltage	V <sub>RWM</sub>	T=25 °C.	-3.3		3.3	V
Leakage Current	I <sub>Leak</sub>	V <sub>RWM</sub> = ±3.3V, T=25 °C.			0.1	μA
Breakdown Voltage	V <sub>BV</sub>	I <sub>BV</sub> = 1mA, T=25 °C.	4.5		8.5	V
ESD Clamping Voltage (Note 1)	V <sub>clamp</sub>	IEC 61000-4-2 +8kV (I <sub>TLP</sub> = 16A), Contact mode, T=25 °C.		12		V
ESD Dynamic Turn-on Resistance	R <sub>dynamic</sub>	IEC 61000-4-2 0~+8kV, T=25 °C, Contact mode.		0.3		Ω
Input Capacitance	C <sub>IN</sub>	V <sub>R</sub> = ±1.65V, f = 1MHz, T=25 °C.		0.45	0.55	pF

Note 1: ESD Clamping Voltage was measured by Transmission Line Pulsing (TLP) System.

TLP conditions: Z<sub>0</sub>= 50Ω, t<sub>p</sub>= 100ns, t<sub>r</sub>= 1ns.



## Typical Characteristics



## Applications Information

The AZ5323-01F is designed to protect one line against System ESD pulse by clamping it to an acceptable reference. It provides bi-directional protection.

The usage of the AZ5323-01F is shown in Fig. 1. Protected line, such as data line, control line, or power line, is connected at pin 1. The pin 2 is connected to a ground plane on the board. In order to minimize parasitic inductance in the board traces, all path lengths connected to the pins of AZ5323-01F should be kept as short as possible.

In order to obtain enough suppression of ESD induced transient, good circuit board is critical. Thus, the following guidelines are recommended:

- Minimize the path length between the protected lines and the AZ5323-01F.
- Place the AZ5323-01F near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- Use ground planes whenever possible.
- NEVER route critical signals near board edges and near the lines which the ESD transient easily injects to.

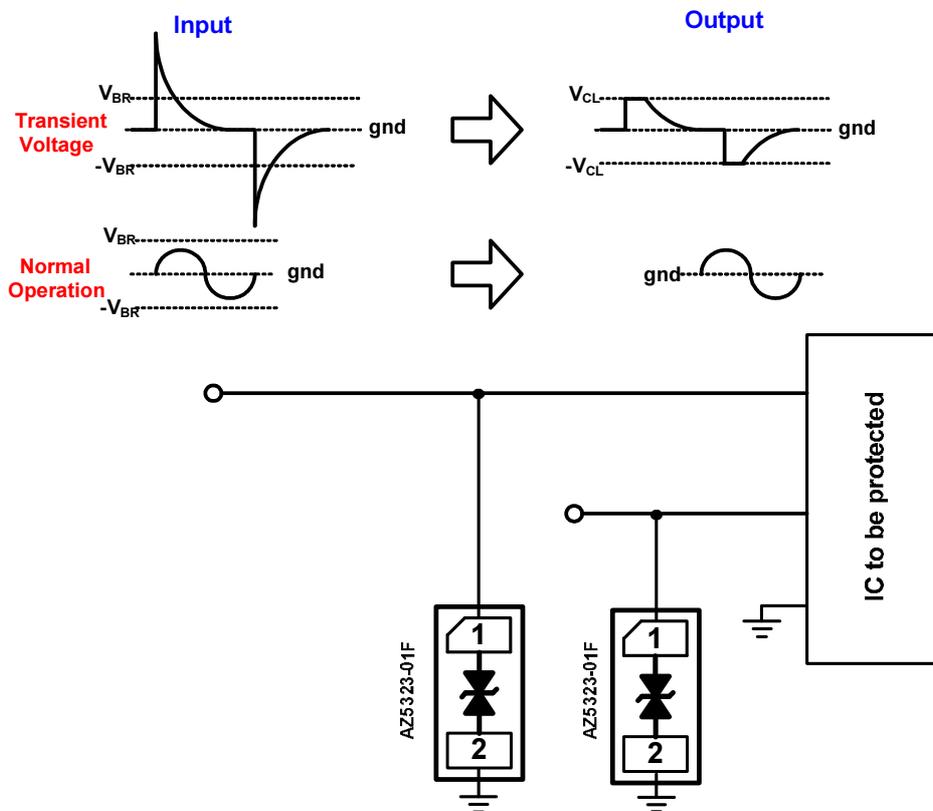
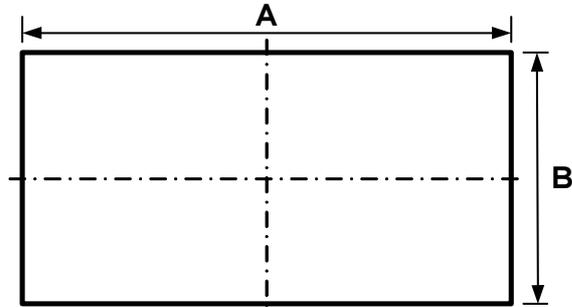


Fig. 1 ESD protection scheme by using AZ5323-01F.



### Mechanical Details

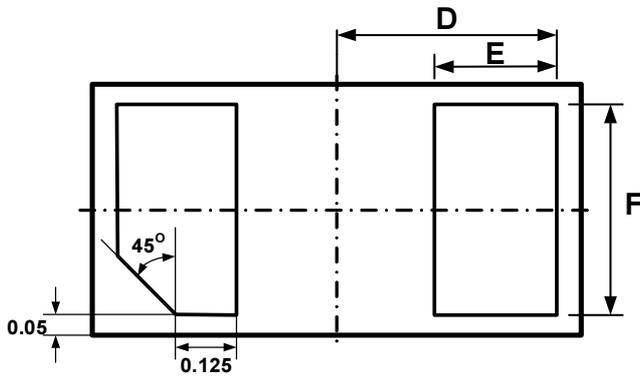
#### DFN1006P2E PACKAGE DIAGRAMS



TOP VIEW



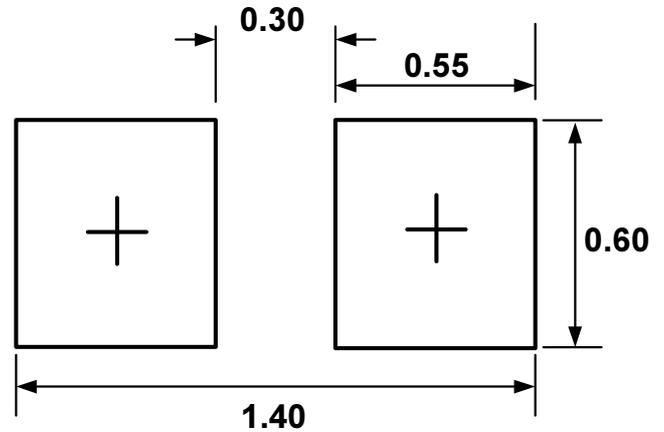
SIDE VIEW



BOTTOM VIEW

Symbol	Millimeters		Inches	
	min	max	min	max
A	0.95	1.05	0.037	0.041
B	0.55	0.65	0.022	0.026
C	0.45	0.60	0.018	0.024
D	0.45		0.018	
E	0.20	0.30	0.008	0.012
F	0.45	0.55	0.018	0.022

### LAND LAYOUT

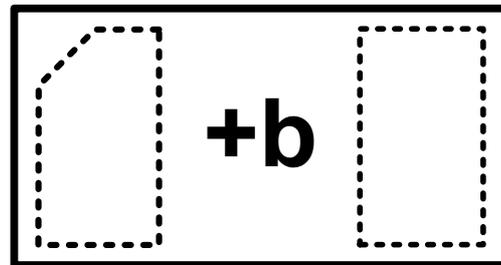


(Unit: mm)

#### Notes:

This LAND LAYOUT is for reference purposes only. Please consult your manufacturing partners to ensure your company's PCB design guidelines are met.

### MARKING CODE



Top View

Part Number	Marking Code
AZ5323-01F.R7GR (Green Part)	b

Note : Green means Pb-free, RoHS, and Halogen free compliant.



## Ordering Information

PN#	Material	Type	Reel size	MOQ	MOQ/internal box	MOQ/carton
AZ5323-01F.R7GR	Green	T/R	7 inch	12,000/reel	4 reels=48,000/box	6 boxes=288,000/carton

## Revision History

Revision	Modification Description
Revision 2015/11/17	Preliminary Release.
Revision 2017/05/11	Formal Release.